

LED技術及應用發展新趨勢

洪盟淵 晶元光電

2009.05.19





Overview of LED Industry
LED Applications
Roadmap to High Efficiency at Injection High Currents
New Technology for Solid State Lighting -ACLED

Global and Taiwan LED Market Trends



Source : ITRI/IEK(2008)

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Worldwide LED Market Outlook for 2009



Source : IEK(2009)

EPISTAR

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LED Notebook Backlight Demands

全球LE	ED 背	光需	求量				單位:百萬顆
應用別	2007	2008	2009f	2010f	2011f	2012f	GAGR%(08-12)
NB	47	687	2,522	4,738	6,443	7,897	84
監視器	0	7	51	160	354	652	211
LCD TV	3	114	1,699	5,484	12,813	26,174	289
總計	50	808	4,272	10,382	19,610	34,723	156
資料 · 業者、DIGITIMES 整理 · 2009/2							製表:韓青秀·游順發

In 2009, there will be around 63M of NB that will use LED backlight, assuming 40 LED in each LED backlight. -> a 40% penetration rate





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LED LCDTV Market Penetration



Source: LEDinside, Witsview



LCD TV with LED Backlight

DIGITIMES

2009/4/2

主要顯示器業者發展TV用LED背光所採型式

廠商	LED 背光源型式	產品特色			
三星電子	側 光式白光LED	40时~55时LCD TV最薄部僅6.5mm,為設 製機種中厚度最薄者。			
	直下式白光LED	動態對比值提升至100萬:1。			
Pore	側 光式白光LED	40吋LCD TV最薄部僅9.9mm,為上市機 種中厚度最薄者。			
Soliy	直下式RGB LED	46吋、55吋仍採用high-power LED設計, 考量因素為色彩管理較易。			
夏普	直下式RGB LED	52吋及65吋LCD TV機身厚僅2.28公分。			
Victor	側光式白光LED	32时LCD TV最薄部僅7mm。			
東芝	直下式RGB LED	動態對比值達100萬:1。			
专法	側光 式白光LED	46时LCD面板LED light bar數縮為2條。			
~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	直下高密度 RGB LED 背光	區域控制所畫分區域細分為1,296區。			
Global Lighting Technologies	<b>側</b> 光式白光LED	LED背光源採單遍放置型式。			
 資料來源:各廠商	萄,DIGITIMES整理,20	009/2			

#### 三星LED節能液晶電視 6月來台上市



## **The Advantage of LED LCDTV**

#### LED背光應用在LCD TV優勢

• 廣色域:

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- --RGB 3色LED 背光NTSC(u' ∀)可達 140%以上
- 白光LED NTSC(u' v')可作到約 95%。
- 調整色溫:
  - 藉由調整RGB LED電流比例,使色温範圍達到LCD TV要求。
  - 白光LED 可利用各圈光體比例的組合,達到某特定波長。
- LCD顯示器可呈90度方向轉動:
  - CCFL型顯示器若由橫向放置轉為直 立放置,則CCFL燈管內的汞會向下 沈積。
  - -LED燈源則無上述問題。
- 可對應至超大型LCD顯示器:
  - CCFL型燈營有長度限制
  - LED由單一光源所組合而成,背光 模組易作到大型化。
- > 薄型化:
  - 尤其是側光式IED能達最佳薄度。

資料來源:DIGITIMES(2008/7

- 區域控制(2D Dimming)可能:
  - 依畫面內容明暗程度作輝度調整
  - 一動態對比值提升
  - 降健耗電量
- RGB LED-Color Sequential :
  - 不需使用CF
    - LCD面板邊光率提高3倍。
    - ・降低和電量
  - 一解析度提高3倍
  - -LED光利用效率高
    - 需某特定颜色時,僅需點亮該顏色
       LED光源。
- 瞬間點滅:

- 因LED光源點滅速度快,可改善 LCD TV動畫表現。
- 啟動電壓低
  - -LED driver IC 僅需低電壓驅動
  - 驅動CCFL的Inverter須使用高電 壓、高電流。
  - 其它:
     → 輝度易調整、無汞、無搽外線等



### **Historical Evolution for Solid State Technology**



### EPISTAR Government Policies in Driving SSL 晶元光電

2009	Taiwan	Plan to replace the incandescent light bulb with LED lamp at 2009 Q1 in government buildings, and are not allowed to manufacture and use incandescent light bulb completely starting from 2012				
	Australia	Plan to ban the incandescent lamp after 2010				
2010	European Union	Plan to ban (producing and using) the incandescent lamp after 2010				
	Japan	The government announced at 2008.04.05. The incandescent light buibs will be completely phased out before 2012				
2012	Canada	Plan to ban using the incandescent lamp after 2012				
2012	California	will phase out the use of incandescent bulbs by 2018.				
Ţ	England	Plan to eliminate incandescent lamp gradually by 2012				



### **Business Model - Vertical Integration Solid State Lighting**





# **Retail Light Source Survey**

Туре	Incandescent		t	PL	Fluor	Fluorescent		CFL		
model	-	<b>MR-16</b>	PAR	2 / 4 pin	<b>T</b> 8	T-5	T3-E27	2U-E27	T2-E14	<b>MR-16</b>
	инъ ha si e; egi:				COSRAM L 36W/880 SUMMUR WAGE A Commary C & T	Consult to served Consult to se		MAXIM BROWNICCE	ighting.en.alibaba.com	
Lm/W	~15	25~35(Xe)	6~15	65~75	60~95	85~95	65~70	50~65	50~55	55~65
W/Pkg	5~100	20~50	50~150	18~30	20~60	14~54	13~28	13~28	5~10	2~5
Lm/Pkg*	~600	~500	~900	~1300	~3000	~3000	~1400	~1200	~350	~250
W/\$	2~9	1	0.5	0.12	0.3~1	0.06~0.13	0.14	0.17	0.05~0.0 8	0.005
Lm/\$*	~60	~20	~5	~9	~30	~8	~10	~10	~3	~0.3
P.F	-	-	-	**	**	**	57%	57%	~55%	-
Lifetime	~1000	~2000	~2500	>12000	8000	10000	3000	3000	3000	>20000
Color. T	Warm	Warm	Warm	Tunable	Tunable	Tunable	Tunable	Tunable	Tunable	Tunable
CRI	>80	>85	>85	>80	~70	>80	~70	~70	~70	>75

* on average ** depends on ballast ** All price in NT\$



# **LED Lighting Applications**



#### 13W LED Light Bulb



Cree Down

Light Module





MR16



EverLight Street Light



Delta Solar Street Light

LRGC

#### **Cost Analysis for Different Lighting Sources**

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### 光譜與植物發育的關係

光譜範圍	對植物生理的影響
280~315nm	對形態與生理過程的影響極小
315~400nm	葉綠素吸收少,影響光周期效應,阻止莖伸長
400~520nm(藍)	葉綠素與類胡蘿蔔素吸收比例最大,對光合作用影響最大
	色素的吸收率不高
520~610nm	葉綠素吸收率低,對光合作用與光周期效應有顯著影響
610~720nm(紅)	吸收率低,刺激細胞延長,影響開花與種子發芽
720~1000nm	轉換成為熱量

Effect of LED irradiation on the rhizocarp shapes of radish Tamulaitis et al. (2005) J. Phys., D: Appl. Phys. 38: 3182-



HPS treatment (high pressure sodium lamps)



455 nm 640 nm LED 660 nm 735 nm



455 nm 640 nm LED 660 nm



Green house

White fluorescent light

660 nm LED 90% 450 nm LED 10%



# **Epistar HB LED Product Line-up**







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### **Efficiency Evolution of Light Sources**





# Efficiency Roadmap (DOE)





# **Luminous Efficiency**

 $\checkmark \text{Luminous Efficiency (lm/W)} = \eta_{pack} \times \eta_{phos} \times \eta_{elec} \times \eta_{int} \times \eta_{extract}$ 

Where

η pack : Packaging Efficiency (optics design)
 η phos : Phosphor Conversion Efficiency (phosphor design)

 $\eta_{elec}$ : Electrical Efficiency (V_f and injection efficiency)

 $\eta_{int}$ : Internal Quantum Efficiency (Epi layer design and quality)

 $\eta_{extract}$ : Light Extraction Efficiency (LED chip structure and device design)

 $\eta_{ext} = \eta_{int} \times \eta_{extract}$  is the External Quantum Efficiency (EQE)

#### EPISTAR Efficiency Breakdown (Phosphor-Converting LED) 晶元光電

Luminaire



Figure 4.5: Phosphor-Converting LED - Current and Target Luminaire Efficiencies for Steady State Operation

Source: LED Technical Committee, Fall 2008 Note:

- 1. The target assumes a CCT of 4100K and CRI of 90. Current CCT: 4100-6500K, CRI: 75
- The target for 2d includes the loss due to the Stokes shift (90% quantum yield times the ratio of the average pumped wavelength and the average wavelength emitted); the value here is typical of a blue diode/yellow phosphor system.
- 3. The shown efficiency allocation is only one method of achieving the 41% luminaire efficiency target.

### EPISTAR 晶元光電

# How Achievable is 150 lm/W ?

#### How Achievable is 150 lm/W ?

#### PC White Todav* Future ~90 C_{ext}(%) ~80 IQE (%) ~55 ~90 EQE (%) ~45 ~80 $V_f(V)$ ~3.3 ~2.9 ~75 WPE (%) ~35 LE (Im/W) ~70 ~150

 * High performance commercial "cool white" LED.

LUMILEDS

1mm² chip driven at 350mA.

- IQE must increase by >1.5X
- This table assumes a phosphor conversion on 200 lumens/optical Watt for "cool" white (CCT >5000).
- For "warm" white (CCT 3000 4000) the conversion is significantly lower and requires development. This is an issue for illumination.
- To achieve 1000 lumen source drive current must be ~2A which reduces luminous efficacy (LE).
   M. George Craford, March 2007, APS



### Improvement of Luminous Efficiency

### ✓ Internal Quantum Efficiency - droop issue

- Epitaxial quality
- Quantum well/barrier design

#### ✓ Light Extraction Efficiency

- Light scattering/diffraction in or on the LED chip
- Reduce the absorption of the reflected/scattered light.

### ✓ Electric Efficiency

- Current spreading (crowding)– "Finger" and Transparent Contact Metal Layer (ITO)
- Reduce forward voltage
- Phosphor Conversion Efficiency
- ✓ Packaging Efficiency

# EPISTAR Droop Issue - Attributions

✓ Droop: External quantum efficiency drops as injection current increases.

- Droop attributions
  - Phonon-assisted Auger Recombination Philips Lumileds, OSRAM
  - Piezoelectric (Polarization) effects in the quantum wells -RPI, Samsung Electro-Mechanics, Virginia Commonwealth Univ
  - Non-radiative recombination West Virginia University
  - Defects

# EPISTAR Device Design Approaches

- ✓ Better current spreading
  - New transparent oxide
  - Optimized contact finger design
  - Thicker n-GaN
- ✓ Better light extraction
  - Surface texturing
  - Interface light path design
- $\checkmark$  Reduce forward voltage, V_f
  - Increase p-GaN doping concentration
  - Reduce contact resistance



# **Power Chip Portfolio**



# Generic



#### Saturn-H Series



ITO on rough p-GaNLeaf vein finger design

ITO on flat p-GaNESS technology

- *ITO on flat p-GaN*
- Lambertion reflector
- *High* k_{thermal} substrate
- Separation of heat dissipation and current path



### Evolution of Power Chip Performance







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### **From Power to Illumination**





### **Worldwide Main Voltage & Frequency**







#### **Efficiency from AC Utility to DC Input**





## **The ACLED Market Forecast**





AC LED chip works under high voltage driven directly.
No additional rectifier or adapter need.
The area size and the numbers of microchips (cells) decide the driving voltage and power.



#### Circuit Layout

- Diode Rectifier

(Seoul Semiconductor)



- Bridge Rectifier (ITRI, Epistar)



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### **Principles Behind AC-Driven LED**

#### Operation Point for DCLED is static



#### Operation Point for ACLED is dynamic





i-v transfer function of diode



Alternating sinusoid voltage
 Alternating non-sinusoid current



### **Principle Behind AC-Driven LED**

#### - I-V Characteristics of AC LED



#### - Poptical & Pelectric - I Characteristics of AC LED



#### Power Factor

- **Real Power:**  $P_{real} = \frac{1}{T} \int_{0}^{T} V(t) I(t) dt$
- Apparent power:

$$P_{apparent} = V_{rms} \times I_{rms}$$

- Power factor is the ratio of the real power to apparent power:

$$P.F. = \frac{P_{real}}{P_{apparent}}$$



#### How to increase the PF ??

- 1. Increase the cell number
- 2. Reduce the operation current
- 3. Add resistor

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### Solutions for Power System Variations

#### Adding a resistor







#### Adding a Capacitor





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# Seoul Semiconductor ACLED

#### ● 外觀



#### ● DC下的近場



等效電路(Diode rectifier type)



#### - 優點

- 每一顆逆向LED所承受的逆向偏壓是一 樣的

不需考慮恆時發亮區及整流區的面積比
 例問題,設計較為單純



Pr

Vf

W

# EPISTAR ACLED Chip Performances

#### (Customer Packaging Data)

oduct Type:									
ES-RD-AC110V-A55-28L-3 (Bin 03)									
@ 10mA (without resistor): ~ 90 V <b>PS</b> : <b>1. LITEON</b> d: 455.0 ~ 460.0 nm <b>2. No Resistor</b> <b>3. η is estimated</b>									
Name	X	Y	Lumen	ССТ	I	V	Efficiency		
No./Unit			lm	К	Irms	Vrms	lm/W		
Min	0.357	0.414	56.29	4575	10.0	92.0	68.0		
Max	0.369	0.430	62.67	4828	10.0	94.0	74.1		
Avg.	0.363	0.422	59.37	4692	10.0	93.3	70.7		
StdDev	0.006	0.008	3.48	112	0.0	0.9			

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#### ES-RD-AC110V-A55-28L

	Driving Voltage :	110V (rms)				
	Driving Current :	12mA (rms)				
Bin	Resister ( $\Omega$ ) :	± 80 (Ω)				
01	1385	5				
02	1230	)				
03	1075					
04	920					
05	765					
06	610					
07	455					
08	300					





# **ACLED Family**

Power Consumption







### **Lower Cost Approach: ACLED**

480 lm @ 4W



Note: The cost of LED chip are only for reference because it depended on performance and chip size.



# **Use AC55 to form Lamps**

	4W AC LED	6W AC LED	15W AC LED	
Туре				
AC LED Module				
LED	AC55 (1W) X 4	AC55 (1W) X 6	AC55 (1W) X 15	
Luminous Flux @ 5700K	230 lm	350 lm	900 lm	
Luminous Flux @ 3000K	160 lm	250 lm	650 lm	



# **Vision With LED**



Photograph: NASA